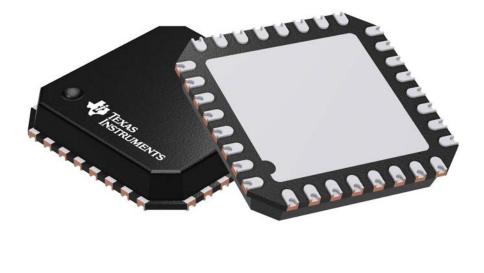
RHM 32

GENERIC PACKAGE VIEW

VQFNP - 0.9 mm max height PLASTIC QUAD FLATPACK - NO LEAD



Images above are just a representation of the package family, actual package may vary. Refer to the product data sheet for package details.



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